



Per OSHPark specs,
 min trace 5mil,
 min space 5mil's,
 min ringlet 4 mil's,
 4 layer board stackup is as follows:
 T-0 is top min 1 oz copper (1.4 mil)
 min 6.7 mil prepreg FR4
 T-1 is GND min 0.5 oz copper (0.7 mil)
 min 47 mil core FR4
 T-2 is PWR min 0.5 oz copper (0.7 mil)
 min 6.7 mil prepreg FR4
 T-3 is bottom min 1 oz copper (1.4 mil)

http://rusefi.com/	
Sheet:	
File: O2_input_CJ125.kicad_pcb	
Title: <i>CJ125 Wide O2</i>	
Size: A	Date: 2017-01-30
KiCad E.D.A. kicad 4.0.5	Rev: R0.3
	Id: 1/1